3.0mmx1.5mm SMD CHIP LED LAMP

Part Number: APL3015QBC/D-F01 Blue



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- 3.0mmx1.5mm SMT LED, 1.4mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

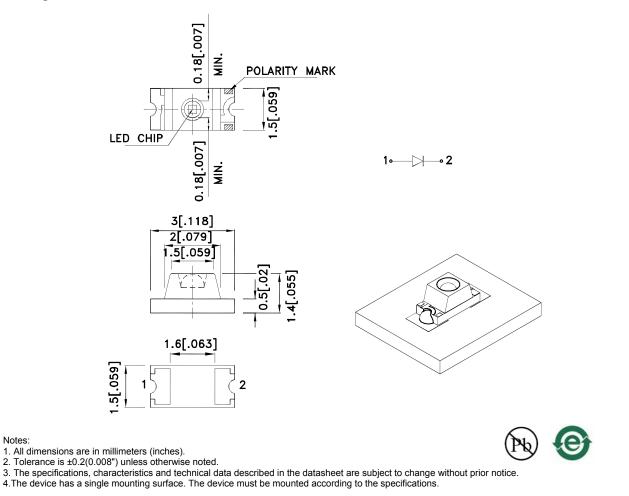
The Blue source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



SPEC NO: DSAH3777 APPROVED: WYNEC REV NO: V.4 CHECKED: Allen Liu DATE: APR/19/2011 DRAWN: J.Yu PAGE: 1 OF 5 ERP: 1203001602

Selection Guide

	Selection Guide					
	Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
				Min.	Тур.	201/2
	APL3015QBC/D-F01	Blue (InGaN)	Water Clear	120	200	70°

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	468		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Blue	470		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Blue	25		nm	I⊧=20mA
С	Capacitance	Blue	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue	3.3	4	V	I⊧=20mA
lr	Reverse Current	Blue		50	uA	Vr=5V

Notes:

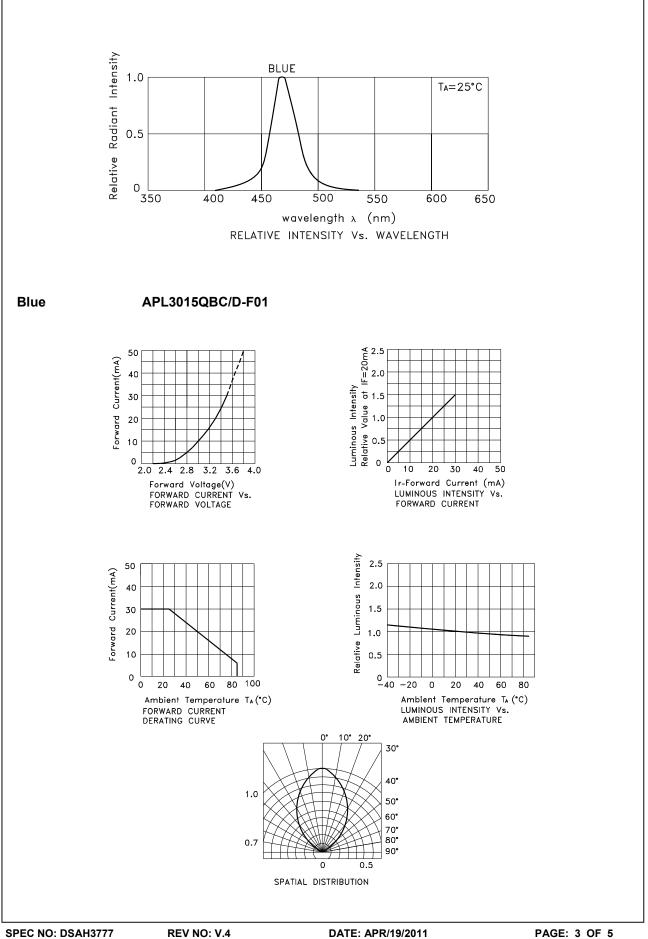
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Blue	Units		
Power dissipation	120	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Note:

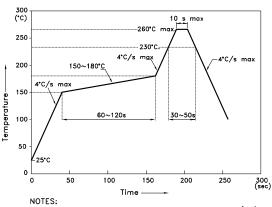
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



APL3015QBC/D-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

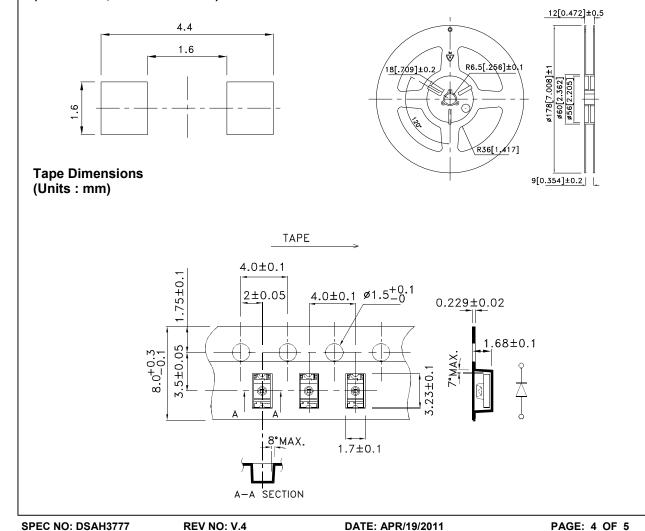
Reflow Soldering Profile For Lead-free SMT Process.



NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



Reel Dimension



DRAWN: J.Yu

